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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

A N	APPL NUM 10099840	FILING DATE 03/12/2002	CLASS 436	SUBCLASS 2812	GAU Q. 10A16	EXAMINER
**APPLICANTS: Hofmann James; S. P.						
**CONTINUING DATA VERIFIED: Note						
** FOREIGN APPLICATIONS VERIFIED: Note						
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>		
Foreign priority claimed		<input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO		
35 USC 119 conditions met		<input type="checkbox"/> yes <input type="checkbox"/> no		MI22-1803		
Verified and Acknowledged Examiner's initials						
TITLE : Methods of forming patterns for semiconductor constructions; and molds configured to pattern masses associated with semiconductor constructions						
U.S. DEPT. OF COMM /PAT & TM-PTO-436L (Rev. 12-94)						

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.		Fig. Drwg.
				Print Fig.
		Primary Examiner		
		Application Examiner		
TERMINAL DISCLAIMER		PREPARED FOR ISSUE		
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